

FEATURES

- Operate with 3.3 V supply**
- Interoperable with 5 V logic**
- EIA RS-422 and RS-485 compliant over full common-mode range**
- Data rate options**
 - ADM3483/ADM3488: 250 kbps**
 - ADM3485/ADM3490/ADM3491: 10 Mbps**
- Half- and full-duplex options**
- Reduced slew rates for low EMI (ADM3483 and ADM3488)**
- 2 nA supply current in shutdown mode (ADM3483/ADM3485/ADM3491)**
- Up to 32 transceivers on the bus**
- 7 V to +12 V bus common-mode range**
- Specified over the -40°C to +85°C temperature range**
- 8 ns skew (ADM3485/ADM3490/ADM3491)**
- 8-lead SOIC and 14-lead SOIC (ADM3491 only) packages**

APPLICATIONS

- Low power RS-485/RS-422 applications**
- Telecom**
- Industrial process control**
- HVAC**

GENERAL DESCRIPTION

The ADM3483/ADM3485/ADM3488/ADM3490/ADM3491 are low power, differential line transceivers designed to operate using a single 3.3 V power supply. Low power consumption, coupled with a shutdown mode, makes the ADM3483/ADM3485/ADM3488/ADM3490/ADM3491 ideal for power-sensitive applications.

The ADM3488/ADM3490/ADM3491 feature full-duplex communication, while the ADM3483/ADM3485 are designed for half-duplex communication.

The ADM3483/ADM3488 feature slew rate limited drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free data transmission at data rates up to 250 kbps.

The ADM3485/ADM3490/ADM3491 transmit at up to 10 Mbps. The receiver input impedance is 12 k Ω , allowing up to 32 transceivers to be connected on the bus. A thermal shutdown circuit prevents excessive power dissipation caused by bus contention or by output shorting. If a significant temperature increase is detected

FUNCTIONAL BLOCK DIAGRAMS

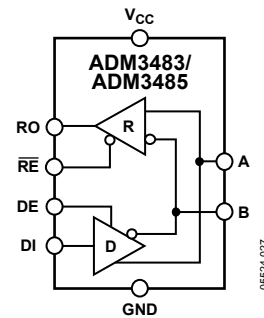


Figure 1.



Figure 2.



Figure 3.

in the internal driver circuitry during fault conditions, then the thermal shutdown circuit forces the driver output into a high impedance state. If the inputs are unconnected (floating), the receiver contains a fail-safe feature that results in a logic high output state. The parts are fully specified over the commercial and industrial temperature ranges. The ADM3483/ADM3485/ADM3488/ADM3490 are available in 8-lead SOIC_N; the ADM3491 is available in a 14-lead SOIC_N.

Rev. E

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

TABLE OF CONTENTS

Features	1	Switching Characteristics	13
Applications.....	1	Circuit Description.....	14
General Description	1	Devices with Receiver/Driver Enables (ADM3483/ADM3485/ADM3491)	14
Functional Block Diagrams.....	1	Devices Without Receiver/Driver Enables— ADM3488/ADM3490	14
Revision History	2	Reduced EMI and Reflections (ADM3483/ADM3488)	14
Specifications.....	4	Low Power Shutdown Mode (ADM3483/ADM3485/ADM3491)	14
Timing Specifications—ADM3485/ADM3490/ADM3491.....	5	Driver Output Protection.....	14
Timing Specifications—ADM3483/ADM3488.....	5	Propagation Delay	14
Timing Specifications— ADM3483/ADM3485/ADM3488/ADM3490/ADM3491	6	Typical Applications.....	14
Absolute Maximum Ratings.....	7	Line Length vs. Data Rate	15
ESD Caution.....	7	Outline Dimensions	17
Pin Configurations and Function Descriptions	8	Ordering Guide	18
Typical Performance Characteristics	9		
Test Circuits.....	11		

REVISION HISTORY

11/11—Rev. D to Rev. E

Changes to Digital I/O Voltage (DE, RE, DI) Parameter, Table 6	7
Moved Typical Performance Characteristics Section	9
Moved Test Circuits Section.....	11
Moved Switching Characteristics Section	13
Changes to Note 1, Table 8	14
Changes to Outline Dimensions.....	17

12/10—Rev. C to Rev. D

Changes to Figure 33.....	15
---------------------------	----

8/10—Rev. B to Rev. C

Changes to Table 2, Driver Input Logic.....	4
---	---

10/06—Rev. A to Rev. B

Updated Format.....	Universal
Added ADM3491	Universal
Changes to Specifications Section.....	4
Changes to Typical Applications Section	14

7/06—Rev. 0 to Rev. A

Changes to Applications	1
Changes to General Description	1
Changes to Figure 19.....	10
Changes to Typical Applications Section	13
Changes to Figure 31 and Figure 32.....	14
Updated Outline Dimensions	15

10/05—Revision 0: Initial Version

Table 1. ADM34xx Part Comparison

Part No.	Guaranteed Data Rate (Mbps)	Supply Voltage (V)	Half-/Full-Duplex	Slew Rate Limited	Driver/Receiver Enable	Shutdown Current (nA)	Pin Count
ADM3483	0.25	3.0 to 3.6	Half	Yes	Yes	2	8
ADM3485	10	3.0 to 3.6	Half	No	Yes	2	8
ADM3488	0.25	3.0 to 3.6	Full	Yes	No	N/A	8
ADM3490	10	3.0 to 3.6	Full	No	No	N/A	8
ADM3491	10	3.0 to 3.6	Full	No	Yes	2	14

SPECIFICATIONS

$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

Table 2.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER					
Differential Output Voltage (V_{OD})	2.0			V	$R_L = 100 \Omega$ (RS-422), $V_{CC} = 3.3 \text{ V} \pm 5\%$ (see Figure 17)
	1.5			V	$R_L = 54 \Omega$ (RS-485) (see Figure 17)
	1.5			V	$R_L = 60 \Omega$ (RS-485), $V_{CC} = 3.3 \text{ V}$ (see Figure 18)
$\Delta V_{OD} $ for Complementary Output States ¹			0.2	V	$R_L = 54 \Omega$ or 100Ω (see Figure 17)
Common-Mode Output Voltage (V_{OC})			3	V	$R_L = 54 \Omega$ or 100Ω (see Figure 17)
$\Delta V_{OC} $ for Common-Mode Output Voltage ¹			0.2	V	$R_L = 54 \Omega$ or 100Ω (see Figure 17)
DRIVER INPUT LOGIC					
CMOS Input Logic Threshold Low (V_{IL})			0.8	V	DE, DI, \overline{RE}
CMOS Input Logic Threshold High (V_{IH})	2.0			V	DE, DI, \overline{RE}
CMOS Logic Input Current (I_{IN1})			± 2	μA	DE, DI, \overline{RE}
Input Current—A, B (I_{IN2})			1.0	mA	$V_{IN} = 12 \text{ V}$, DE = 0 V, $V_{CC} = 0 \text{ V}$ or 3.6 V
			-0.8	mA	$V_{IN} = -7 \text{ V}$, DE = 0 V, $V_{CC} = 0 \text{ V}$ or 3.6 V
Output Leakage—Y, Z (I_o)		0.1		μA	$V_{IN} = 12 \text{ V}$, DE = 0 V, $\overline{RE} = 0 \text{ V}$, $V_{CC} = 0 \text{ V}$ or 3.6 V, ADM3491 only
		-0.1		μA	$V_{IN} = -7 \text{ V}$, DE = 0 V, $\overline{RE} = 0 \text{ V}$, $V_{CC} = 0 \text{ V}$ or 3.6 V, ADM3491 only
Output Leakage (Y, Z) in Shutdown Mode (I_o)		0.01		μA	$V_{IN} = 12 \text{ V}$, DE = 0 V, $\overline{RE} = V_{CC}$, $V_{CC} = 0 \text{ V}$ or 3.6 V, ADM3491 only
		-0.01		μA	$V_{IN} = -7 \text{ V}$, DE = 0 V, $\overline{RE} = V_{CC}$, $V_{CC} = 0 \text{ V}$ or 3.6 V, ADM3491 only
RECEIVER					
Differential Input Threshold Voltage (V_{TH})	-0.2		+0.2	V	$-7 \text{ V} < V_{CM} < +12 \text{ V}$
Input Hysteresis (ΔV_{TH})		50		mV	$V_{CM} = 0 \text{ V}$
CMOS Output Voltage High (V_{OH})	$V_{CC} - 0.4$			V	$I_{OUT} = -1.5 \text{ mA}$, $V_{ID} = 200 \text{ mV}$ (see Figure 19)
CMOS Output Voltage Low (V_{OL})			0.4	V	$I_{OUT} = 2.5 \text{ mA}$, $V_{ID} = 200 \text{ mV}$ (see Figure 19)
Three-State Output Leakage Current (I_{OZR})			± 1	μA	$V_{CC} = 3.6 \text{ V}$, $0 \text{ V} \leq V_{OUT} \leq V_{CC}$
Input Resistance (R_{IN})	12			k Ω	$-7 \text{ V} < V_{CM} < +12 \text{ V}$
POWER SUPPLY CURRENT					
Supply Current (I_{CC})		1.1	2.2	mA	DE = V_{CC} , $\overline{RE} = 0 \text{ V}$ or V_{CC} , no load, DI = 0 V or V_{CC}
		0.95	1.9	mA	DE = 0 V, $\overline{RE} = 0 \text{ V}$, no load, DI = 0 V or V_{CC}
Supply Current in Shutdown Mode (I_{SHDN})		0.002	1	μA	DE = 0 V, $\overline{RE} = V_{CC}$, DI = V_{CC} or 0 V
Driver Short-Circuit Output Current (I_{OSD})			-250	mA	$V_{OUT} = -7 \text{ V}$
			250	mA	$V_{OUT} = 12 \text{ V}$
Receiver Short-Circuit Output Current (I_{OSR})	± 8		± 60	mA	$0 \text{ V} < V_{RO} < V_{CC}$

¹ ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when DI input changes state.

TIMING SPECIFICATIONS—ADM3485/ADM3490/ADM3491

$V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 3.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER					
Differential Output Delay (t_{DD})	1	22	35	ns	$R_L = 60\ \Omega$ (see Figure 20 and Figure 26)
Differential Output Transition Time (t_{TD})	3	8	25	ns	$R_L = 60\ \Omega$ (see Figure 20 and Figure 26)
Propagation Delay, Low-to-High Level (t_{PLH})	7	22	35	ns	$R_L = 27\ \Omega$ (see Figure 21 and Figure 27)
Propagation Delay, High-to-Low Level (t_{PHL})	7	22	35	ns	$R_L = 27\ \Omega$ (see Figure 21 and Figure 27)
$ t_{PLH} - t_{PHL} $ Propagation Delay Skew ¹ (t_{PDS})			8	ns	$R_L = 27\ \Omega$ (see Figure 21 and Figure 27)
DRIVER OUTPUT ENABLE/DISABLE TIMES (ADM3485/ADM3491 ONLY)					
Output Enable Time to Low Level (t_{PZL})		45	90	ns	$R_L = 110\ \Omega$ (see Figure 23 and Figure 29)
Output Enable Time to High Level (t_{PZH})		45	90	ns	$R_L = 110\ \Omega$ (see Figure 22 and Figure 28)
Output Disable Time from High Level (t_{PHZ})		40	80	ns	$R_L = 110\ \Omega$ (see Figure 22 and Figure 28)
Output Disable Time from Low Level (t_{PLZ})		40	80	ns	$R_L = 110\ \Omega$ (see Figure 23 and Figure 29)
Output Enable Time from Shutdown to Low Level (t_{PSL})		650	900	ns	$R_L = 110\ \Omega$ (see Figure 23 and Figure 29)
Output Enable Time from Shutdown to High Level (t_{PSH})		650	900	ns	$R_L = 110\ \Omega$ (see Figure 22 and Figure 28)

¹ Measured on $|t_{PLH}(Y) - t_{PHL}(Y)|$ and $|t_{PLH}(Z) - t_{PHL}(Z)|$.

TIMING SPECIFICATIONS—ADM3483/ADM3488

$V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 4.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
DRIVER					
Differential Output Delay (t_{DD})	600	900	1400	ns	$R_L = 60\ \Omega$ (see Figure 20 and Figure 26)
Differential Output Transition Time (t_{TD})	400	700	1200	ns	$R_L = 60\ \Omega$ (see Figure 20 and Figure 26)
Propagation Delay, Low-to-High Level (t_{PLH})	700	1000	1500	ns	$R_L = 27\ \Omega$ (see Figure 21 and Figure 27)
Propagation Delay, High-to-Low Level (t_{PHL})	700	1000	1500	ns	$R_L = 27\ \Omega$ (see Figure 21 and Figure 27)
$ t_{PLH} - t_{PHL} $ Propagation Delay Skew ¹ (t_{PDS})		100		ns	$R_L = 27\ \Omega$ (see Figure 21 and Figure 27)
DRIVER OUTPUT ENABLE/DISABLE TIMES (ADM3483 ONLY)					
Output Enable Time to Low Level (t_{PZL})		900	1300	ns	$R_L = 110\ \Omega$ (see Figure 23 and Figure 29)
Output Enable Time to High Level (t_{PZH})		600	800	ns	$R_L = 110\ \Omega$ (see Figure 22 and Figure 28)
Output Disable Time from High Level (t_{PHZ})		50	80	ns	$R_L = 110\ \Omega$ (see Figure 22 and Figure 28)
Output Disable Time from Low Level (t_{PLZ})		50	80	ns	$R_L = 110\ \Omega$ (see Figure 23 and Figure 29)
Output Enable Time from Shutdown to Low Level (t_{PSL})		1.9	2.7	μs	$R_L = 110\ \Omega$ (see Figure 23 and Figure 29)
Output Enable Time from Shutdown to High Level (t_{PSH})		2.2	3.0	μs	$R_L = 110\ \Omega$ (see Figure 22 and Figure 28)

¹ Measured on $|t_{PLH}(Y) - t_{PHL}(Y)|$ and $|t_{PLH}(Z) - t_{PHL}(Z)|$.

TIMING SPECIFICATIONS—ADM3483/ADM3485/ADM3488/ADM3490/ADM3491

$V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 5.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
RECEIVER					
Time to Shutdown (t_{SHDN})					
ADM3483/ADM3485/ADM3491 ¹	80	190	300	ns	
Propagation Delay, Low-to-High Level (t_{RPLH})					
ADM3485/ADM3490/ADM3491	25	65	90	ns	$V_{ID} = 0\text{ V to }3.0\text{ V}$, $C_L = 15\text{ pF}$ (see Figure 24 and Figure 30)
ADM3483/ADM3488	25	75	120	ns	
Propagation Delay, High-to-Low Level (t_{RPHL})					
ADM3485/ADM3490/ADM3491	25	65	90	ns	$V_{ID} = 0\text{ V to }3.0\text{ V}$, $C_L = 15\text{ pF}$ (see Figure 24 and Figure 30)
ADM3483/ADM3488	25	75	120	ns	
$ t_{PLH} - t_{PHL} $ Propagation Delay Skew (t_{RPDS})					
ADM3485/ADM3490/ADM3491			10	ns	$V_{ID} = 0\text{ V to }3.0\text{ V}$, $C_L = 15\text{ pF}$ (see Figure 24 and Figure 30)
ADM3483/ADM3488			20	ns	
RECEIVER OUTPUT ENABLE/DISABLE TIMES (ADM3483/ADM3485/ADM3491 ONLY)					
Output Enable Time to Low Level (t_{PRZL})		25	50	ns	$C_L = 15\text{ pF}$ (see Figure 25 and Figure 31)
Output Enable Time to High Level (t_{PRZH})		25	50	ns	$C_L = 15\text{ pF}$ (see Figure 25 and Figure 31)
Output Disable Time from High Level (t_{PRHZ})		25	45	ns	$C_L = 15\text{ pF}$ (see Figure 25 and Figure 31)
Output Disable Time from Low Level (t_{PRLZ})		25	45	ns	$C_L = 15\text{ pF}$ (see Figure 25 and Figure 31)
Output Enable Time from Shutdown to Low Level (t_{PRSL})		720	1400	ns	$C_L = 15\text{ pF}$ (see Figure 25 and Figure 31)
Output Enable Time from Shutdown to High Level (t_{PRSH})		720	1400	ns	$C_L = 15\text{ pF}$ (see Figure 25 and Figure 31)

¹ The transceivers are put into shutdown by bringing the \overline{RE} high and DE low. If the inputs are in this state for less than 80 ns, the parts are guaranteed not to enter shutdown. If the parts are in this state for 300 ns or more, the parts are guaranteed to enter shutdown.

ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 6.

Parameter	Rating
V_{CC} to GND	7 V
Digital I/O Voltage (DE, $\overline{\text{RE}}$, DI)	-0.3 V to +6 V
Digital I/O Voltage (RO)	$V_{CC} - 0.5 \text{ V}$ to $V_{CC} + 0.5 \text{ V}$
Driver Output/Receiver Input Voltage	-7.5 V to +12.5 V
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	-65°C to +125°C
θ_{JA} Thermal Impedance	
8-Lead SOIC	121°C/W
14-Lead SOIC	86°C/W
Lead Temperature	
Soldering (10 sec)	300°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION



ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



Figure 4. ADM3483/ADM3485 Pin Configuration



Figure 5. ADM3488/ADM3490 Pin Configuration



Figure 6. ADM3491 Pin Configuration

Table 7. Pin Function Descriptions

ADM3483/ ADM3485 Pin No.	ADM3488/ ADM3490 Pin No.	ADM3491 Pin No.	Mnemonic	Description
1	2	2	RO	Receiver Output. When enabled, if $A > B$ by 200 mV, then $RO = \text{high}$. If $A < B$ by 200 mV, then $RO = \text{low}$.
2	Not applicable	3	\overline{RE}	Receiver Output Enable. A low level enables the receiver output, RO. A high level places it in a high impedance state. If \overline{RE} is high and DE is low, the device enters a low power shutdown mode.
3	Not applicable	4	DE	Driver Output Enable. A high level enables the driver differential Output A and Output B. A low level places it in a high impedance state. If \overline{RE} is high and DE is low, the device enters a low power shutdown mode.
4	3	5	DI	Driver Input. With a half-duplex part when the driver is enabled, a logic low on DI forces A low and B high while a logic high on DI forces A high and B low. With a full-duplex part when the driver is enabled, a logic low on DI forces Y low and Z high while a logic high on DI forces Y high and Z low.
5	4	6, 7	GND	Ground.
Not applicable	5	9	Y	Noninverting Driver Output.
Not applicable	6	10	Z	Inverting Driver Output.
6	Not applicable	Not applicable	A	Noninverting Receiver Input A and Noninverting Driver Output A.
Not applicable	8	12	A	Noninverting Receiver Input A.
7	Not applicable	Not applicable	B	Inverting Receiver Input B and Inverted Driver Output B.
Not applicable	7	11	B	Inverting Receiver Input B.
8	1	13, 14	V_{CC}	Power Supply ($3.3 \text{ V} \pm 0.3 \text{ V}$).
Not applicable	Not applicable	1, 8	NC	No Connect.

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 7. Output Current vs. Receiver Output Low Voltage



Figure 10. Receiver Output Low Voltage vs. Temperature, $I_{RO} = 2.5 \text{ mA}$



Figure 8. Output Current vs. Receiver Output High Voltage



Figure 11. Driver Output Current vs. Differential Output Voltage



Figure 9. Receiver Output High Voltage vs. Temperature, $I_{RO} = 1.5 \text{ mA}$



Figure 12. Driver Differential Output Voltage vs. Temperature, $R_L = 54 \Omega$



Figure 13. Output Current vs. Driver Output Low Voltage

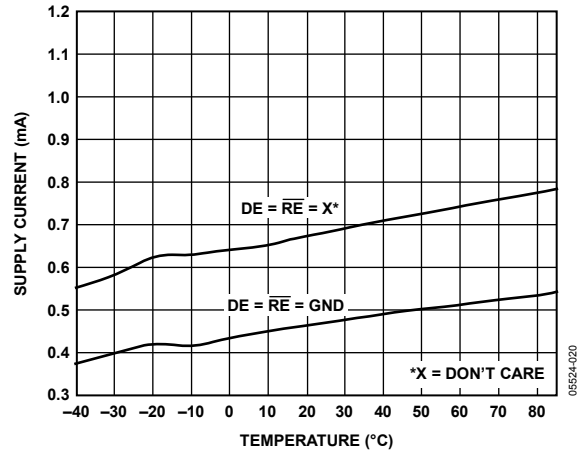


Figure 15. Supply Current vs. Temperature



Figure 14. Output Current vs. Driver Output High Voltage

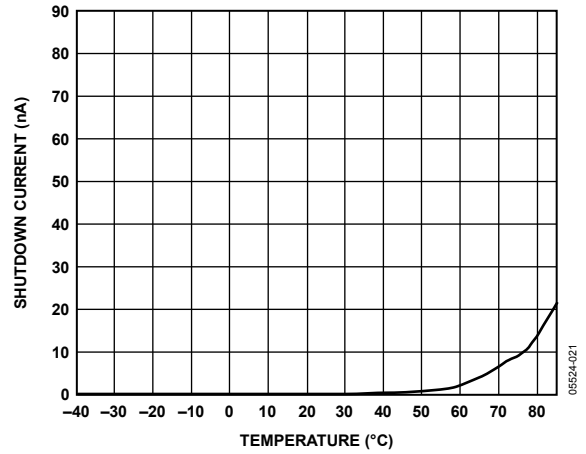


Figure 16. Shutdown Current vs. Temperature

TEST CIRCUITS

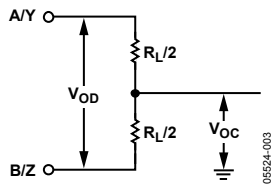


Figure 17. Differential Output Voltage and Common-Mode Voltage Drivers



Figure 18. Differential Output Voltage Drivers with Varying Common-Mode Voltage

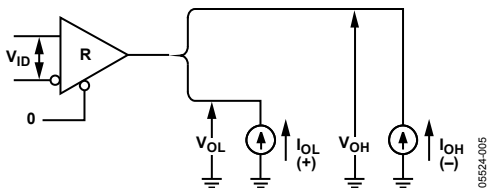


Figure 19. CMOS Output Voltage High and CMOS Output Voltage Low Receivers



¹PPR = 250kHz, 50% DUTY CYCLE, $t_R \leq 6.0ns$, $Z_O = 50\Omega$.
² C_L INCLUDES PROBE AND STRAY CAPACITANCE.

Figure 20. Driver Differential Output Delay and Transition Times



¹PPR = 250kHz, 50% DUTY CYCLE, $t_R \leq 6.0ns$, $Z_O = 50\Omega$.
² C_L INCLUDES PROBE AND STRAY CAPACITANCE.

Figure 21. Driver Propagation Delays



¹PPR = 250kHz, 50% DUTY CYCLE, $t_R \leq 6.0ns$, $Z_O = 50\Omega$.
² C_L INCLUDES PROBE AND STRAY CAPACITANCE.

Figure 22. Driver Enable and Disable Times (t_{PZH} , t_{PSH} , t_{PHZ})



¹PPR = 250kHz, 50% DUTY CYCLE, $t_R \leq 6.0\text{ns}$, $Z_O = 50\Omega$.
² C_L INCLUDES PROBE AND STRAY CAPACITANCE.

06524-039

Figure 23. Driver Enable and Disable Times (t_{PZL} , t_{PSL} , t_{PLZ})



¹PPR = 250kHz, 50% DUTY CYCLE, $t_R \leq 6.0\text{ns}$, $Z_O = 50\Omega$.
² C_L INCLUDES PROBE AND STRAY CAPACITANCE.

06524-041

Figure 25. Receiver Enable and Disable Times



¹PPR = 250kHz, 50% DUTY CYCLE, $t_R \leq 6.0\text{ns}$, $Z_O = 50\Omega$.
² C_L INCLUDES PROBE AND STRAY CAPACITANCE.

06524-040

Figure 24. Receiver Propagation Delays

SWITCHING CHARACTERISTICS



Figure 26. Driver Differential Output Delay and Transition Times



Figure 28. Driver Enable and Disable Times (t_{PZH} , t_{PSH} , t_{PHZ})



Figure 27. Driver Propagation Delays

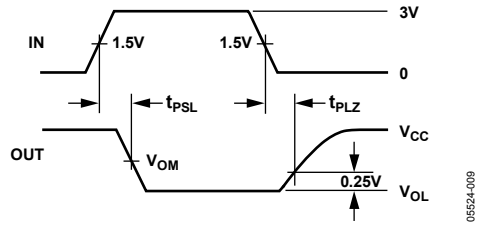


Figure 29. Driver Enable and Disable Times (t_{PZL} , t_{PSL} , t_{PLZ})



Figure 30. Receiver Propagation Delays

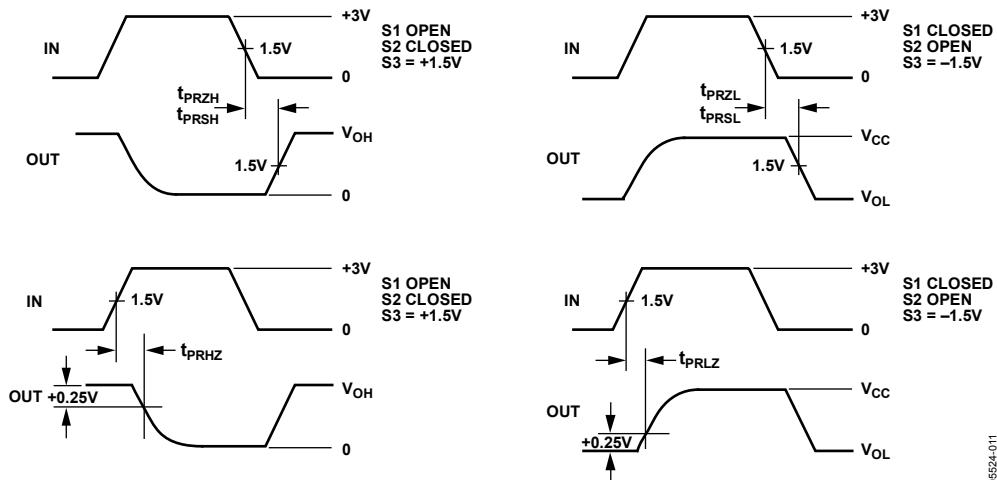


Figure 31. Receiver Enable and Disable Times

CIRCUIT DESCRIPTION

The ADM3483/ADM3485/ADM3488/ADM3490/ADM3491 are low power transceivers for RS-485 and RS-422 communications. The ADM3483/ADM3488 transmit and receive at data rates up to 250 kbps; the ADM3485/ADM3490/ADM3491 transmit at up to 10 Mbps. The ADM3488/ADM3490/ADM3491 are full-duplex transceivers, while the ADM3483/ADM3485 are half-duplex transceivers. Driver enable (DE) and receiver enable ($\overline{\text{RE}}$) pins are included on the ADM3483/ADM3485/ADM3491. When disabled, the driver and receiver outputs are high impedance.

DEVICES WITH RECEIVER/DRIVER ENABLES (ADM3483/ADM3485/ADM3491)

Table 8. Transmitting Truth Table

Transmitting Input			Transmitting Output		Mode
$\overline{\text{RE}}$	DE	DI	B ¹	A ¹	
X ²	1	1	0	1	Normal
X ²	1	0	1	0	Normal
0	0	X ²	High-Z ³	High-Z ³	Normal
1	0	X ²	High-Z ³	High-Z ³	Shutdown

¹ A and B outputs are Y and Z, respectively, for full-duplex part (ADM3491).

² X = don't care.

³ High-Z = high impedance.

Table 9. Receiving Truth Table

Receiving Input			Receiving Output	Mode
$\overline{\text{RE}}$	DE ¹	A – B	RO	
0	0	$\geq +0.2\text{ V}$	1	Normal
0	0	$\leq -0.2\text{ V}$	0	Normal
0	0	Inputs Open	1	Normal
1	0	X ²	High-Z ³	Shutdown

¹ DE is a don't care; X for the full-duplex part (ADM3491).

² X = don't care.

³ High-Z = high impedance.

DEVICES WITHOUT RECEIVER/DRIVER ENABLES— ADM3488/ADM3490

Table 10. Transmitting Truth Table

Transmitting Input	Transmitting Output	
DI	Z	Y
1	0	1
0	1	0

Table 11. Receiving Truth Table

Receiving Input	Receiving Output
A – B	RO
$\geq +0.2\text{ V}$	1
$\leq -0.2\text{ V}$	0
Inputs open	1

REDUCED EMI AND REFLECTIONS (ADM3483/ADM3488)

The ADM3483/ADM3488 are slew rate limited transceivers, minimizing EMI and reducing reflections caused by improperly terminated cables.

LOW POWER SHUTDOWN MODE (ADM3483/ADM3485/ADM3491)

A low power shutdown mode is initiated by bringing $\overline{\text{RE}}$ high and DE low. The devices do not shut down unless both the driver and receiver are disabled (high impedance). In shutdown mode, the devices typically draw only 2 nA of supply current. For these devices, the t_{PSH} and t_{PSL} enable times assume the part is in the low power shutdown mode; the t_{PZH} and t_{PZL} enable times assume the receiver or driver was disabled, but the part is not shut down.

DRIVER OUTPUT PROTECTION

Two methods are implemented to prevent excessive output current and power dissipation caused by faults or by bus contention. Current limit protection on the output stage provides immediate protection against short circuits over the whole common-mode voltage range (see the Typical Performance Characteristics section). In addition, a thermal shutdown circuit forces the driver outputs into a high impedance state if the die temperature rises excessively.

PROPAGATION DELAY

Skew time is the difference between the low-to-high and high-to-low propagation delays. Small driver/receiver skew times help maintain a symmetrical mark-space ratio (50% duty cycle). The receiver skew time ($|t_{\text{PRLH}} - t_{\text{PRHL}}|$) is under 10 ns (20 ns for ADM3483/ADM3488). The driver skew times are 8 ns for ADM3485/ADM3490/ADM3491 and typically under 100 ns for ADM3483/ADM3488.

TYPICAL APPLICATIONS

The ADM3483/ADM3485/ADM3491 transceivers are designed for half-duplex bidirectional data communications on multipoint bus transmission lines, Figure 32 and Figure 33 show typical network applications circuits. The ADM3488 and the ADM3490 full-duplex transceivers are designed to be used in a daisy-chain network topology or in a point-to-point application, see Figure 34 and Figure 35. The ADM3491 can be used as line repeat Figure 36. To minimize reflections, the line must be terminated at both ends in its characteristic impedance, and stub lengths off the main line must be kept as short as possible. The slew rate limited ADM3483/ADM3488 are more tolerant of imperfect termination.

LINE LENGTH vs. DATA RATE

The RS-485 and RS-422 standards cover line lengths up to 4000 feet. For line lengths greater than 4000 feet, see Figure 36.



NOTES
1. R_T IS EQUAL TO THE CHARACTERISTIC IMPEDANCE OF THE CABLE.

Figure 32. ADM3483/ADM3485 Typical Half-Duplex RS-485 Network

05524-022



NOTES
1. R_T IS EQUAL TO THE CHARACTERISTIC IMPEDANCE OF THE CABLE.

Figure 33. ADM3491 Typical Full-Duplex RS-485 Network

05524-090



Figure 34. ADM3488/ADM3490 Full-Duplex Daisy-Chain Network

05524-042

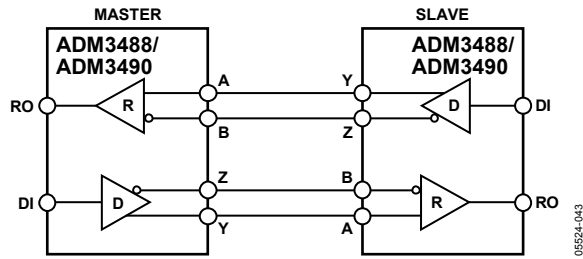


Figure 35. ADM3488/ADM3490 Full-Duplex Point-to-Point Applications

05524-043



- NOTES
 1. R_T IS EQUAL TO THE CHARACTERISTIC IMPEDANCE OF THE CABLE.

Figure 36. Line Repeater for ADM3491

05524-091

OUTLINE DIMENSIONS

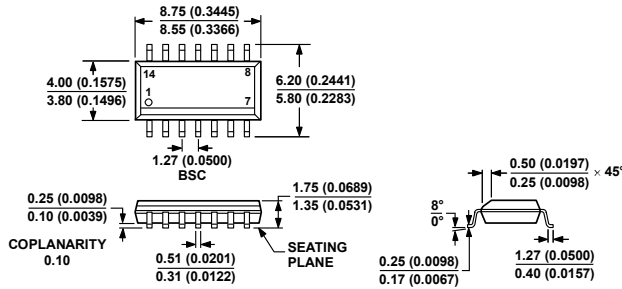


COMPLIANT TO JEDEC STANDARDS MS-012-AA
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
 (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 37. 8-Lead Standard Small Outline Package [SOIC_N]
 Narrow Body
 (R-8)

Dimensions shown in millimeters and (inches)

012407-A



COMPLIANT TO JEDEC STANDARDS MS-012-AB
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
 (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 38. 14-Lead Narrow Body Small Outline [SOIC_N]
 Narrow Body
 (R-14)

Dimensions shown in millimeters and (inches)

000006-A

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option	Ordering Quantity
ADM3483ARZ	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	
ADM3483ARZ-REEL7	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	1,000
ADM3485ARZ	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	
ADM3485ARZ-REEL7	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	1,000
ADM3488ARZ	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	
ADM3488ARZ-REEL7	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	1,000
ADM3490ARZ	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	
ADM3490ARZ-REEL7	-40°C to +85°C	8-Lead Narrow Body Small Outline (SOIC_N)	R-8	1,000
ADM3491AR	-40°C to +85°C	14-Lead Narrow Body Small Outline (SOIC_N)	R-14	
ADM3491AR-REEL	-40°C to +85°C	14-Lead Narrow Body Small Outline (SOIC_N)	R-14	2,500
ADM3491AR-REEL7	-40°C to +85°C	14-Lead Narrow Body Small Outline (SOIC_N)	R-14	1,000
ADM3491ARZ	-40°C to +85°C	14-Lead Narrow Body Small Outline (SOIC_N)	R-14	
ADM3491ARZ-REEL	-40°C to +85°C	14-Lead Narrow Body Small Outline (SOIC_N)	R-14	2,500
ADM3491ARZ-REEL7	-40°C to +85°C	14-Lead Narrow Body Small Outline (SOIC_N)	R-14	1,000

¹ Z = RoHS Compliant Part.

NOTES

NOTES

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9